IGBT

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop (FS) Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for half bridge resonant applications. Incorporated into the device is a soft and fast co-packaged free wheeling diode with a low forward voltage.

Features

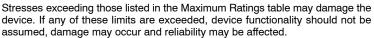
- Extremely Efficient Trench with Fieldstop Technology
- Low Switching Loss Reduces System Power Dissipation
- Optimized for Low Losses in IH Cooker Application
- $T_{Jmax} = 175^{\circ}C$
- Soft, Fast Free Wheeling Diode
- This is a Pb-Free Device

Typical Applications

- Inductive Heating
- Soft Switching

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V _{CES}	650	V
Collector current @ Tc = 25°C @ Tc = 100°C	I _C	80 40	A
Pulsed collector current, T _{pulse} limited by T _{Jmax}	I _{CM}	160	A
Diode forward current @ Tc = 25°C @ Tc = 100°C	I _F	80 40	A
Diode pulsed current, $\rm T_{pulse}$ limited by $\rm T_{Jmax}$	I _{FM}	160	A
Gate-emitter voltage Transient Gate Emitter Voltage ($t_p = 5 \ \mu s, D < 0.010$)	V_{GE}	±20 ±30	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P _D	300 150	W
Operating junction temperature range	TJ	–55 to +175	°C
Storage temperature range	T _{stg}	–55 to +175	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

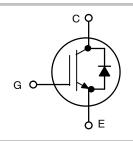


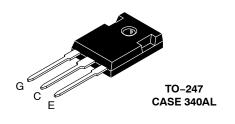


ON Semiconductor®

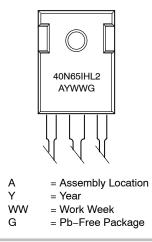
www.onsemi.com

40 A, 650 V V_{CEsat} = 1.8 V E_{off} = 0.36 mJ





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTB40N65IHL2WG	TO–247 (Pb–Free)	30 Units / Rail

THERMAL CHARACTERISTICS

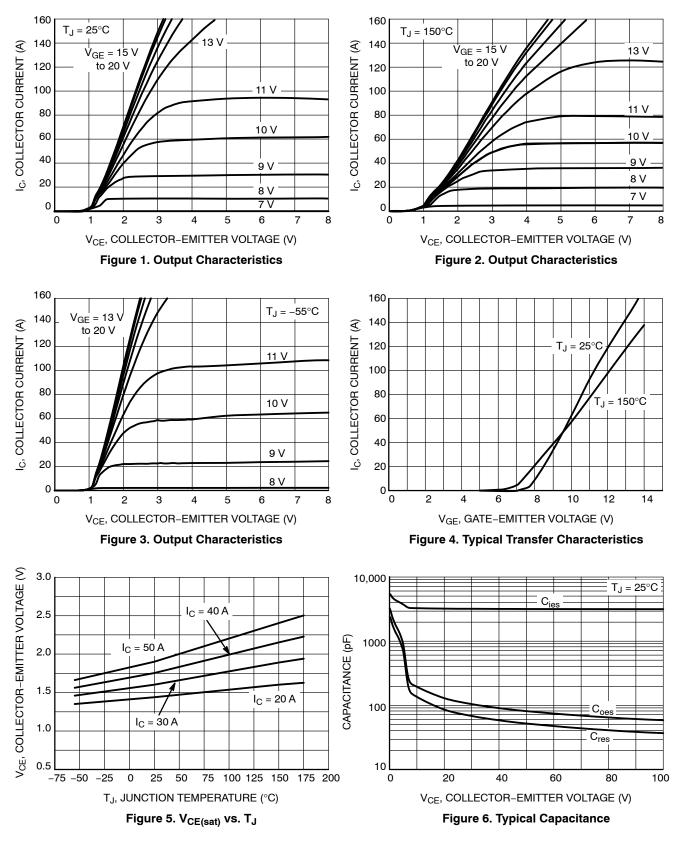
Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.50	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ ext{ heta}JC}$	1.46	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

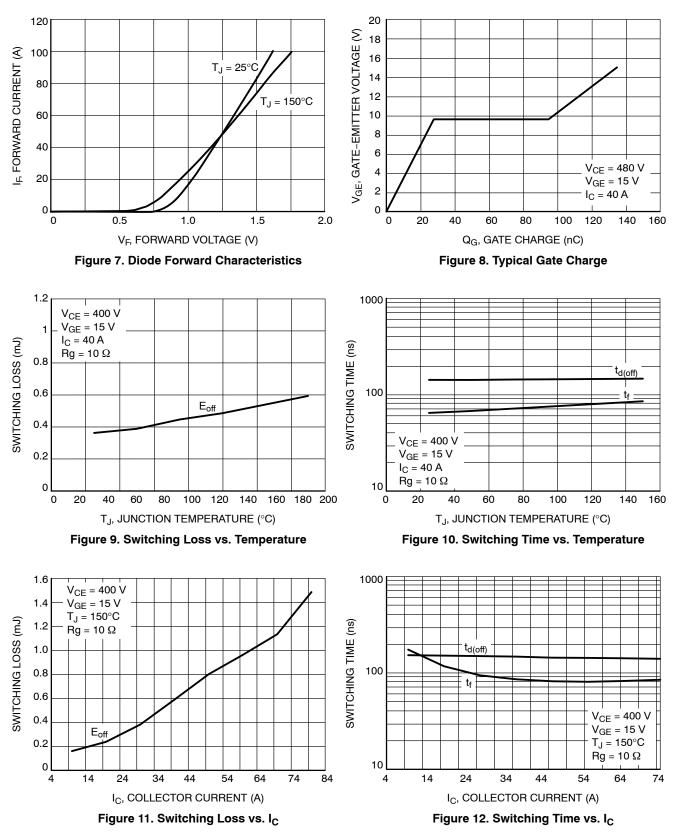
ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

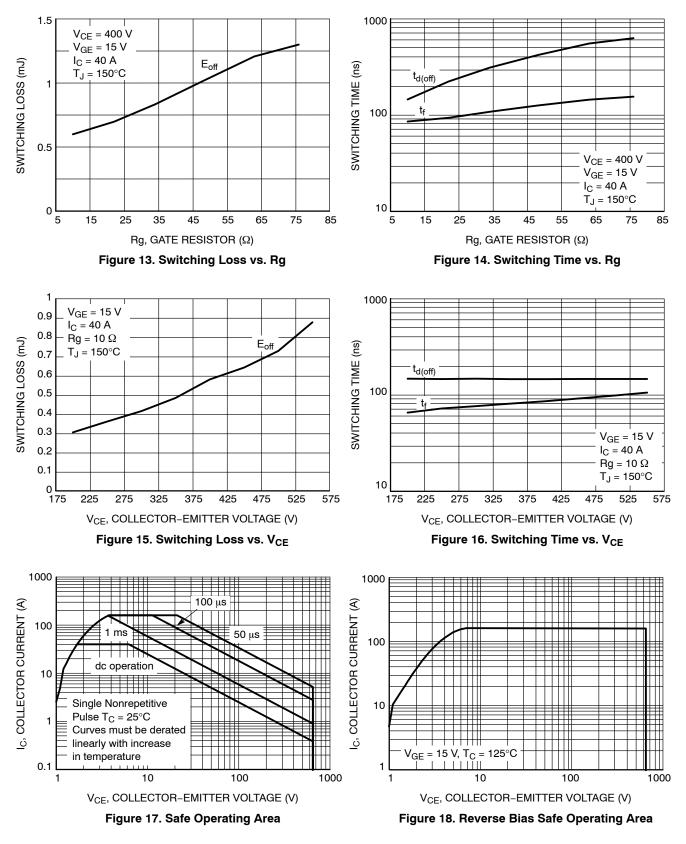
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC		•				
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 500 μ A	V _{(BR)CES}	650	-	_	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 40 A V _{GE} = 15 V, I _C = 40 A, T _J = 175°C	V _{CEsat}	-	1.8 2.3	2.2	V
Gate-emitter threshold voltage	V_{GE} = V_{CE} , I_C = 150 μ A	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	V_{GE} = 0 V, V_{CE} = 650 V V_{GE} = 0 V, V_{CE} = 650 V, T_{J} = 175°C	I _{CES}	-		0.2 2	mA
Gate leakage current, collector-emitter short-circuited	V_{GE} = 20 V , V_{CE} = 0 V	I _{GES}	_	-	100	nA
DYNAMIC CHARACTERISTIC		1		•		
Input capacitance	V _{CE} = 20 V, V _{GE} = 0 V, f = 1 MHz	C _{ies}	-	3200	_	pF
Output capacitance		C _{oes}	-	130	_	
Reverse transfer capacitance		C _{res}	_	85	_	
Gate charge total		Qg	_	135	_	nC
Gate to emitter charge	V _{CE} = 480 V, I _C = 40 A, V _{GE} = 15 V	Q _{ge}	_	27	_	
Gate to collector charge		Q _{gc}	_	67	_	
SWITCHING CHARACTERISTIC, INDUCT						
Turn-off delay time	$\begin{array}{c} {{T_{J}} = 25^\circ C} \\ {{V_{CC}} = 400 \text{ V, I}_C = 40 \text{ A}} \\ {{R_g} = 10 \ \Omega} \\ {{V_{GE}} = 0 \text{ V/ 15 V}} \end{array}$	t _{d(off)}	-	140	-	ns
Fall time		t _f	-	65	-	
Turn-off switching loss		E _{off}	-	0.36	-	mJ
Turn-off delay time	$\begin{array}{c} {T_{J}} = 150^{\circ}{C} \\ {V_{CC}} = 400 \; \text{V}, {I_{C}} = 40 \; \text{A} \\ {R_{g}} = 10 \; \Omega \\ {V_{GE}} = 0 \; \text{V} / \; 15 \; \text{V} \end{array}$	t _{d(off)}	-	150	-	ns
Fall time		t _f	-	85	-	
Turn-off switching loss		E _{off}	_	0.60	_	mJ
DIODE CHARACTERISTIC						
Forward voltage	V_{GE} = 0 V, I _F = 40 A V_{GE} = 0 V, I _F = 40 A, T _J = 175°C	V _F	-	1.2 1.16	1.4 -	V
Reverse recovery time	T.I = 25°C	t _{rr}	-	465	-	ns
Reverse recovery charge	$I_{\rm J} = 200 \text{ V}$ $I_{\rm F} = 40 \text{ A}, \text{ V}_{\rm R} = 200 \text{ V}$ $di_{\rm F}/dt = 200 \text{ A}/\mu\text{s}$	Q _{rr}	_	8700	-	nc
Reverse recovery current		I _{rrm}	-	36	-	А

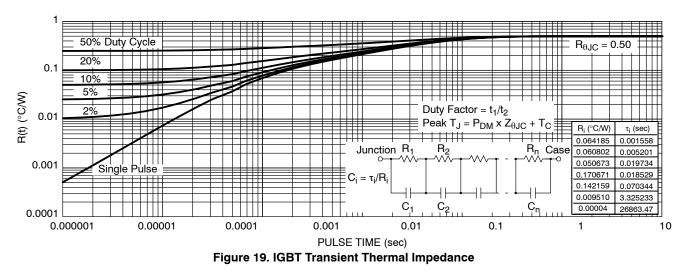
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

I_{rrm}









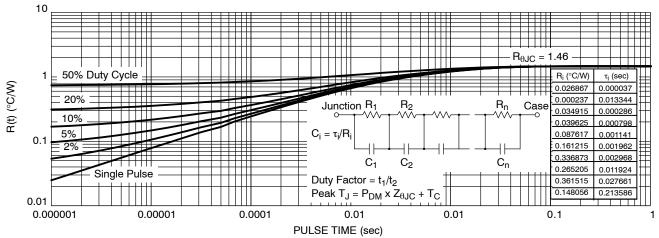


Figure 20. Diode Transient Thermal Impedance

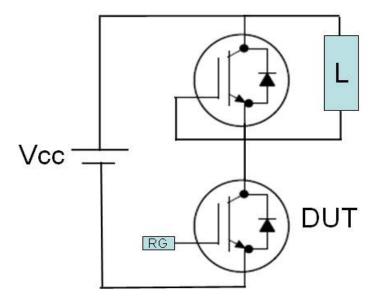
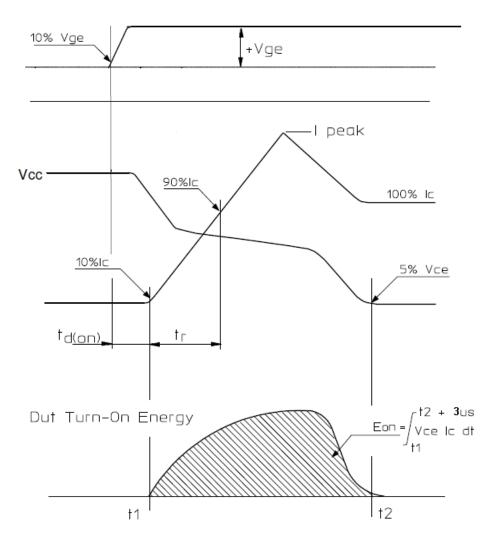
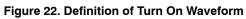


Figure 21. Test Circuit for Switching Characteristics





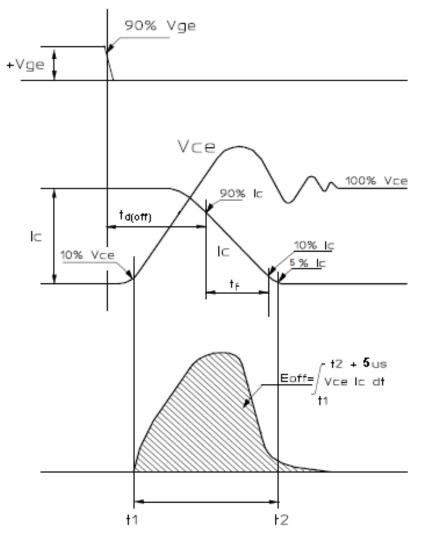
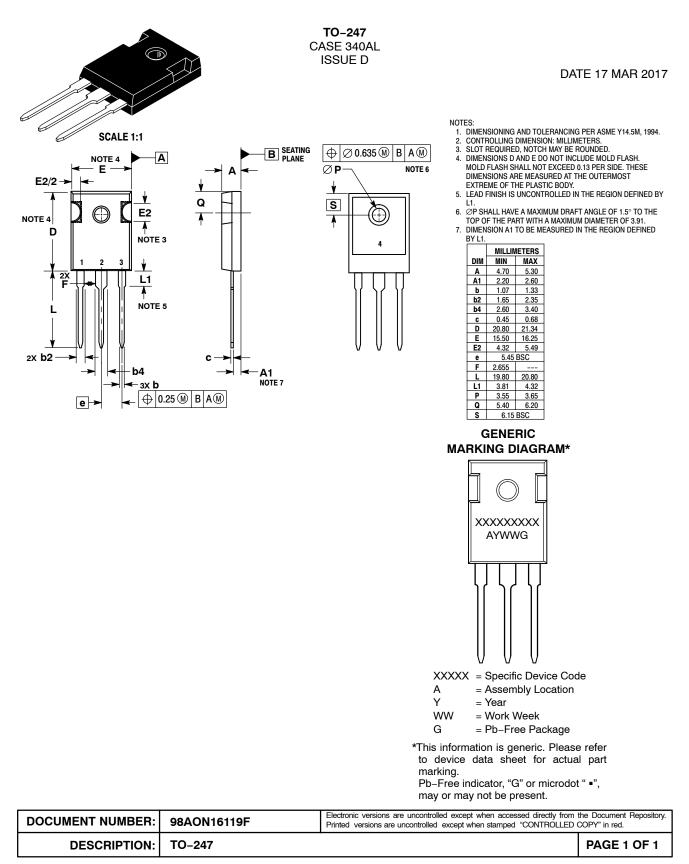


Figure 23. Definition of Turn Off Waveform

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS





ON Semiconductor and (III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at www.onsemi.com/support/sales